

PATENT ASSIGNMENT

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NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Evan G. Colgan	08/24/2011
Luke D. LaCroix	08/23/2011
Mark C.H. Lamorey	08/23/2011
David B Stone	08/23/2011
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13219084
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ATTORNEY DOCKET NUMBER:	BUR920110041US1
NAME OF SUBMITTER:	Andrew M. Calderon
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CH \$40.00 13219084

ASSIGNMENT

Whereas, the undersigned Inventor(s) has/have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") in:

Title of the Invention:

PACKAGING IDENTICAL CHIPS IN A STACKED STRUCTURE

and further identified by the IBM Docket Number provided above in the header of this Assignment, for which an application for a United States Patent was executed concurrently herewith or was filed having:

Serial Number: 13/219,084 (insert series code and serial number here if/when available)

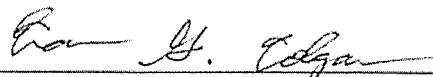
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Each undersigned Inventor acknowledges their prior and ongoing obligations to sell, assign, and transfer the rights under this Assignment to IBM and is unaware of any reason why they may not have the full and unencumbered right to sell, assign, and transfer the rights hereby sold, assigned, and transferred, and has not executed, and will not execute, any document or instrument in conflict herewith. Each undersigned Inventor also hereby grants IBM, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent application Serial Number) which may be necessary or desirable for recordation of this Assignment. This Assignment is governed by the substantive laws of the State of New York, and any disputes will be resolved in a New York state court or federal court sited in New York.

[Inventor Signature Page(s) Follows]

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Signature:  Date: 8/24/11
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Luke D. LaCroix

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Mark C. H. Lamorey

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David B. Stone

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